



Fully automatic gas source wafer biscuit making  
line biscuit wafer machinery wafer production line

Bearing No.

Size	30.6x72x19 mm
Bore Diameter	30,6 mm
Outer Diameter	72 mm
Width	19 mm
d	30,6 mm
D	72 mm
B	19 mm
C	19 mm

Bearing 2D drawings and 3D CAD models